Receipt d	ot date: 04/21/201 of commerce patent and trademark office			ATTY. DOCKET NO096 SURMET-002PUS		1 & 74 ICA (DOALNO 174 09/618,741			
	INFORMATION DISCLOSURE CITATION				APPLICANT				
	(Use several sheets if necessary)				Thomas M. Hartnett, et al.				
				FILING DATE July 18, 2000		GROUP 1741			
***************************************	U.S	S. PATENT DO	CUMENT	rs					
EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME CL		LASS SUB-	SS A	FILING DATE IF APPROPRIATE*		
		шш-р							
	FOR	EIGN PATEN	r docum	ENTS			TRANSLATION		
EXAMINER INITIAL	DOCUMENT NUMBER	D	TE	NAME	CLASS	SUB- CLASS	YES NO		
	JPS 58-074514	05-07-19	83	Raytheon Company					
	JP H05-294737	11-09-19	93	Raytheon Company					
	GB 2126568A	03-28-19	84	Hartnett					
	JP S58-074577	05-06-19	83	Raytheon Company					
	GB 2108945A	05-25-19	83	Hartnett					
	English Abstract JP H97-187620	07-25-19	95	Mitsui Tuatsu Chem Inc.					
	JP H07-187620	07-25-19	95	Mitsui Tuatsu Chem Inc.[0026] – [0027]					
						N. S.			
				10.50					
	/								
	/								
							1		

Dagaint do	to. 04/03/0013		T	21 0 7 4 1 - A 1 1 - 4 i				
Seceibi de	ite: 04/21/201.s. DEPAI	ATTY. DOCKET NO.	APPLICATION NO.					
	PATENT A	ND TRADEMARK OFFICE	SURMET-002PUS	09/618,741				
	INFORMATION DISCLOSU	APPLICANT						
			Thomas M. Hartnett, et al.					
	(Use several sheets if n	ecessary)	FILING DATE	GROUP				
		Page 2 of 2	July 18, 2000	1741				
	OTHER DOCUMI	ENTS (including Author, Title, 1	Date, Pertinent Pages, Etc.)					
	NORMAN D. CORBIN, A 1989, Vol 5. No. 3, pp. 14	uluminum Oxynitride Spinel; A F 43-154.	Review, Journal of the Euro	pean Ceramic Society,				
	JAMES W MCCAULEY et al. Phase relations and reaction sintering of transparent cubic aluminum oxynitride spinel (ALON), Journal of the Ceramic Society of America, 1979, Vol. 62, Nos. 9-11. pp 476-479.							
Examiner	/John Hoffmann/							
	*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and considered. Include copy of this form with next communication to applicant.							
(702143)								